

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	30	V
RMS Reverse Voltage		V _{R(RMS)}	21	V
Average Rectified Forward Current		lo	100	mA
Forward Continuous Current (Note 6)		I _F	200	mA
Repetitive Peak Forward Current (Note 6)		I _{FRM}	300	mA
Forward Surge Current (Note 6)	@ t < 1.0s	I _{FSM}	600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	200	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ ext{ heta}JA}$	625	°C/W
Operating and Storage Temperature Range (Note 8)	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	30		_	V	I _R = 100μA
Forward Voltage	V _{FM}	_	_	240 320 400 500 1000	mV	$I_{F} = 0.1mA$ $I_{F} = 1mA$ $I_{F} = 10mA$ $I_{F} = 30mA$ $I_{F} = 100mA$
Reverse Leakage Current (Note 7)	I _{RM}	_	_	2.0	μA	V _R = 25V
Total Capacitance	CT	_	_	10	pF	V _R = 1.0V, f = 1.0MHz
Reverse Recovery Time	t _{RR}	_	_	5.0	ns	$I_F = 10mA$ through $I_R = 10mA$ to $I_R = 1.0mA$, $R_L = 100\Omega$

6. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

7. Short duration pulse test used to minimize self-heating effect. 8. $\frac{d P_{tot}}{d T_J} > \frac{1}{R_{\theta JA}}$ thermal runaway condition for a diode on its own heatsink.

Notes:





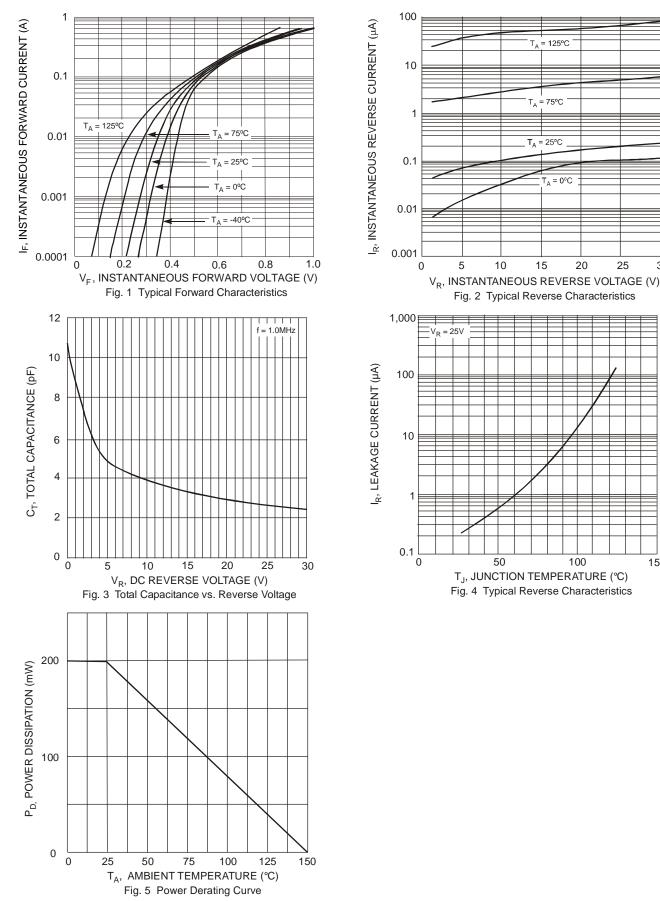
20

100

25

30

150

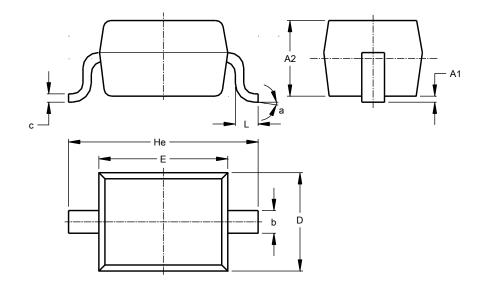




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD323

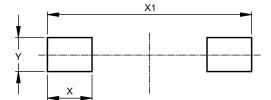


SOD323				
Dim	Min	Max	Тур	
A1		0.10	0.05	
A2	1.00	1.10	1.05	
b	0.25	0.35	0.30	
С	0.10	0.15	0.11	
D	1.20	1.40	1.30	
Е	1.60	1.80	1.70	
He	2.30	2.70	2.50	
L	0.20	0.40	0.30	
а	0°	8º		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
Х	0.590
X1	2.700
Y	0.450



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